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(12) **United States Design Patent**
Li et al.

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(54) **HEADPHONE**
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(51) **LOC (12) Cl.** **14-01**

(52) **U.S. Cl.**
USPC **D14/206; D14/226**

(58) **Field of Classification Search**
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2/209; 381/374, 370, 380, 381;
455/90.3, 575.1, 569.1
CPC H04R 25/00; H04R 25/02; H04R 1/1066;
H04R 1/1016; H04R 5/033; H04R
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See application file for complete search history.

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(57) **CLAIM**

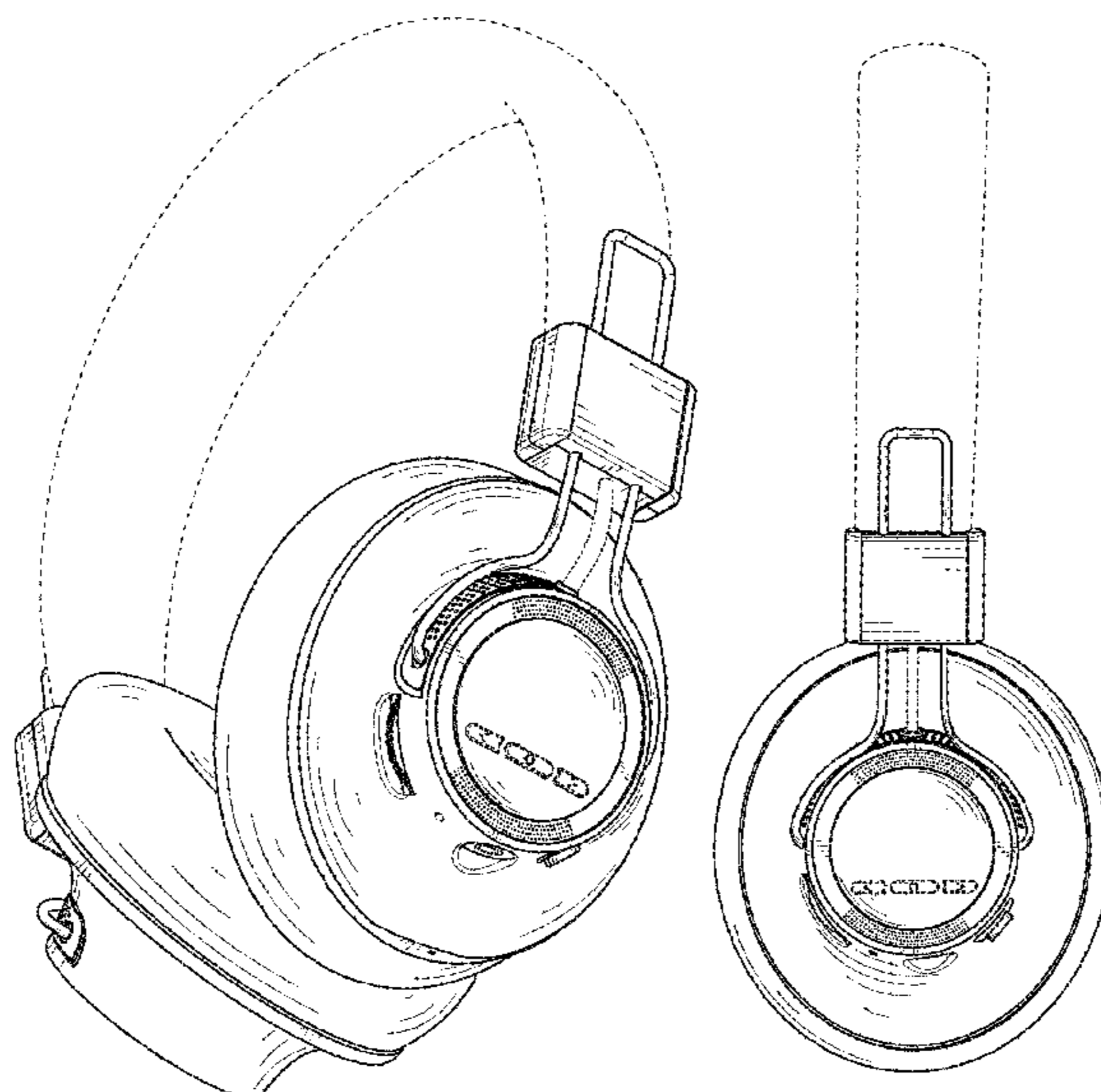
The ornamental design for a headphone, as shown and described.

DESCRIPTION

FIG. 1 is a front, right side, bottom perspective view of a headphone showing my new design;
FIG. 2 is a front elevational view thereof;
FIG. 3 is a rear elevational view thereof;
FIG. 4 is a left side elevational view thereof;
FIG. 5 is a right side elevational view thereof;
FIG. 6 is a top plan view thereof; and,
FIG. 7 is a bottom plan view thereof.

The broken lines immediately adjacent to the claimed portions are boundaries, all other broken lines are environmental structures; all the broken lines form no part of the claimed design.

1 Claim, 7 Drawing Sheets



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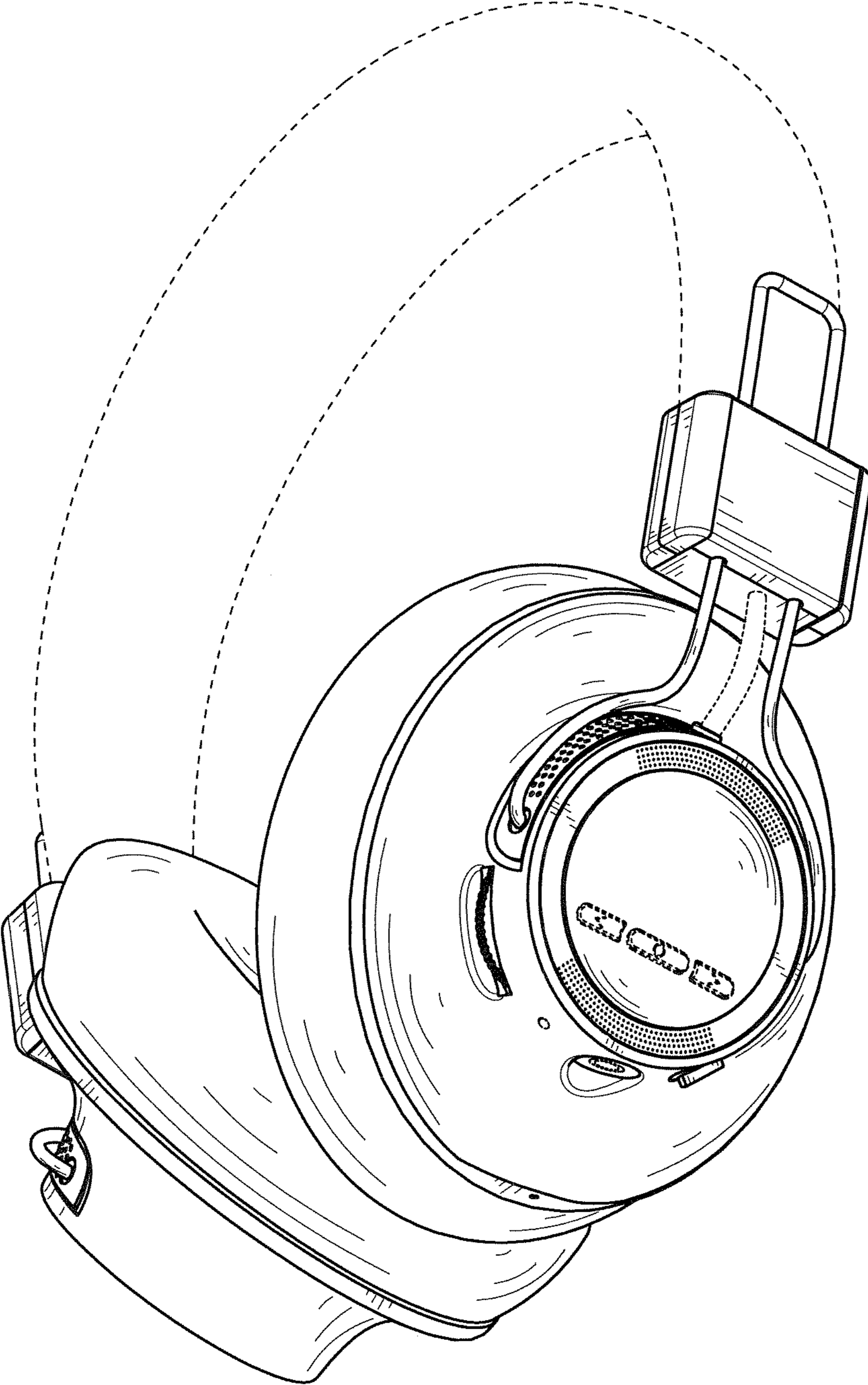


FIG. 1

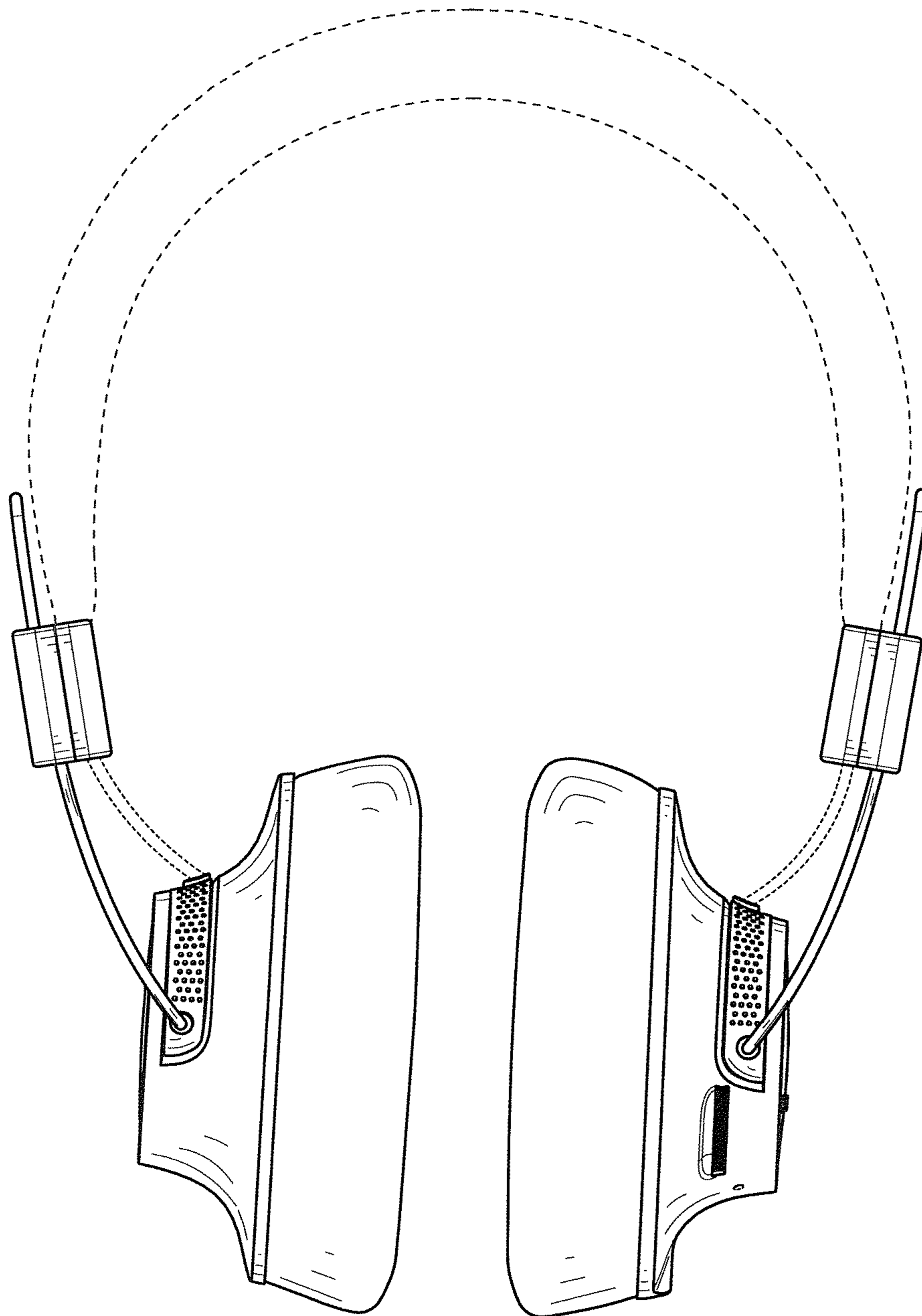


FIG. 2

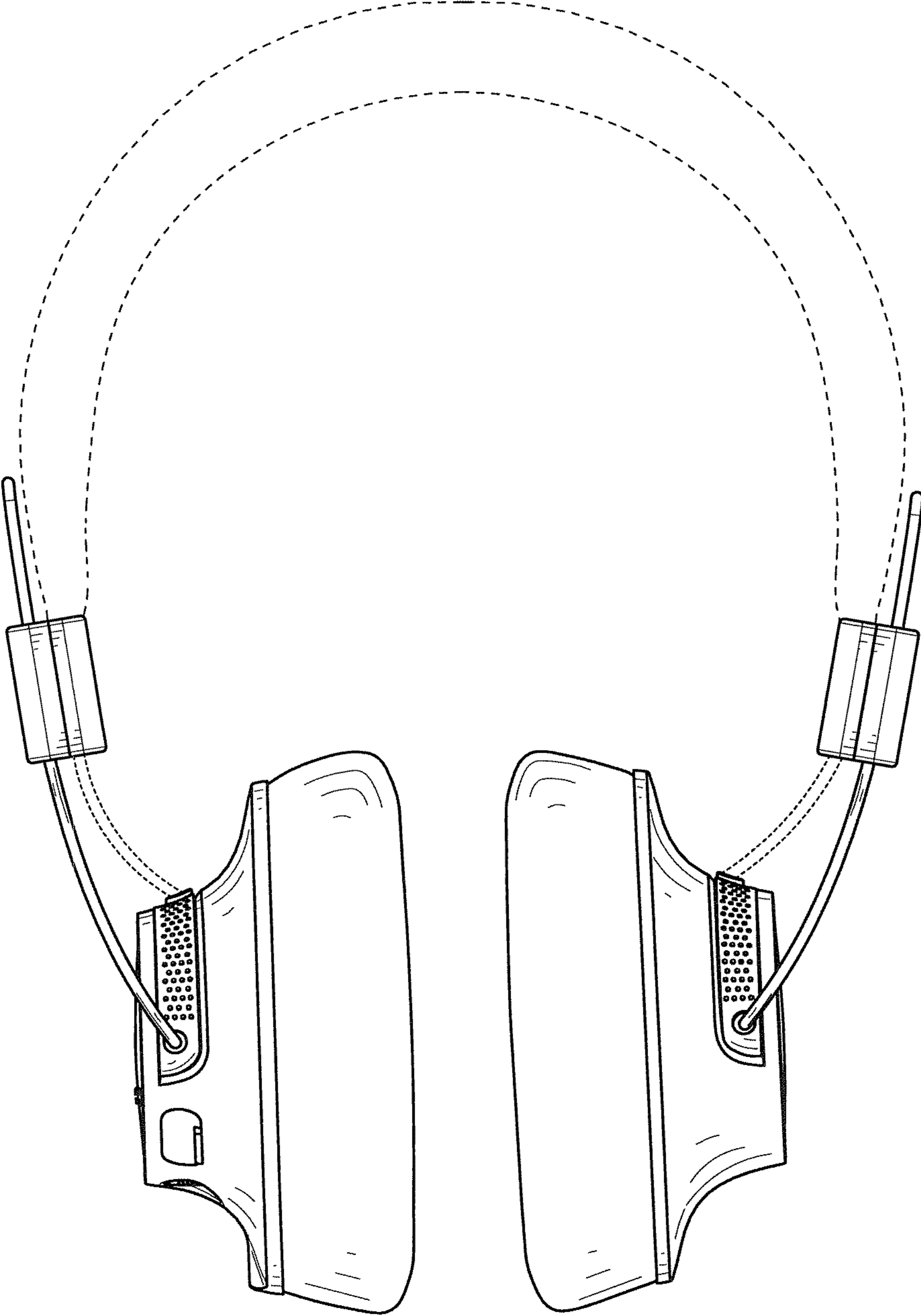


FIG. 3

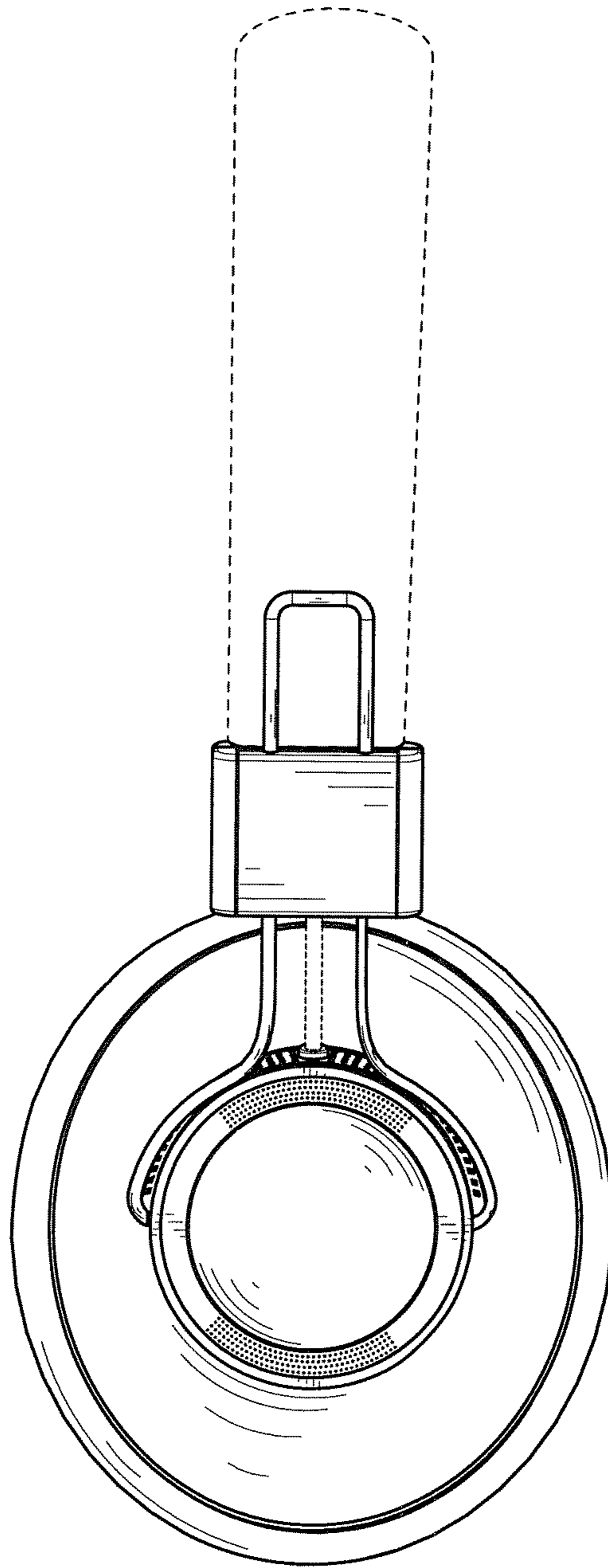


FIG. 4

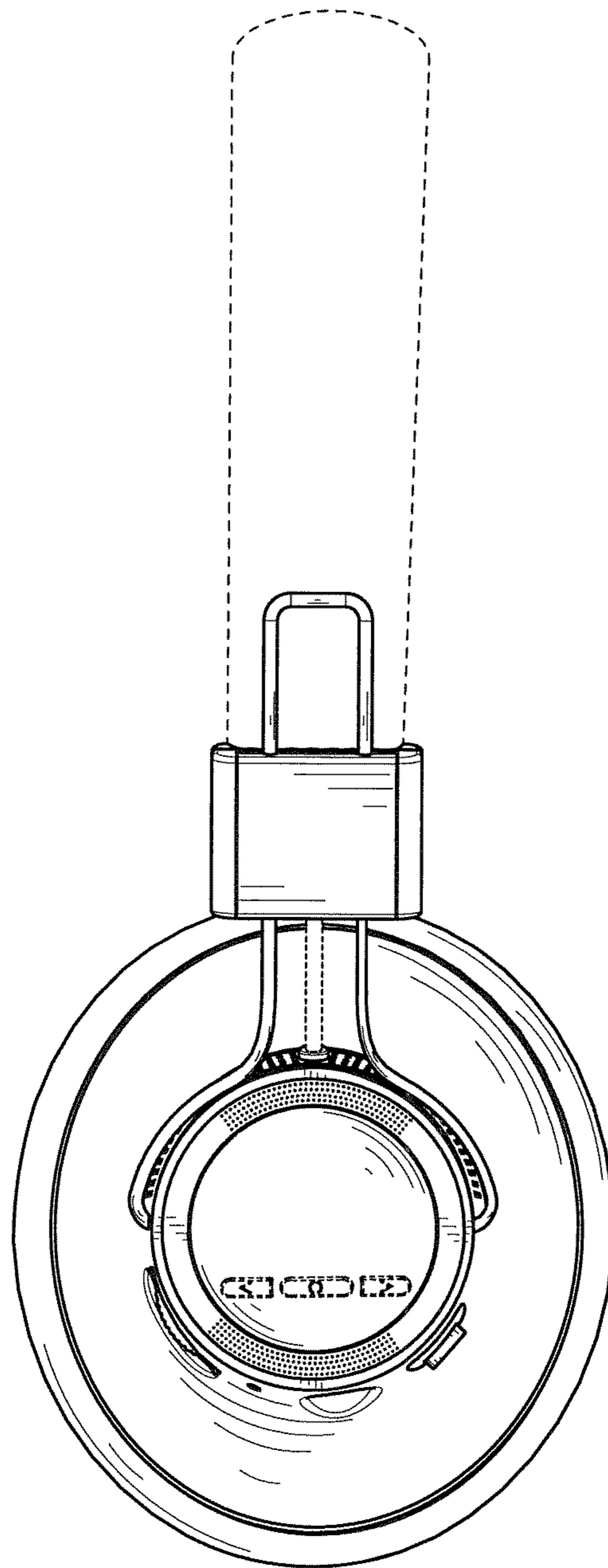


FIG. 5

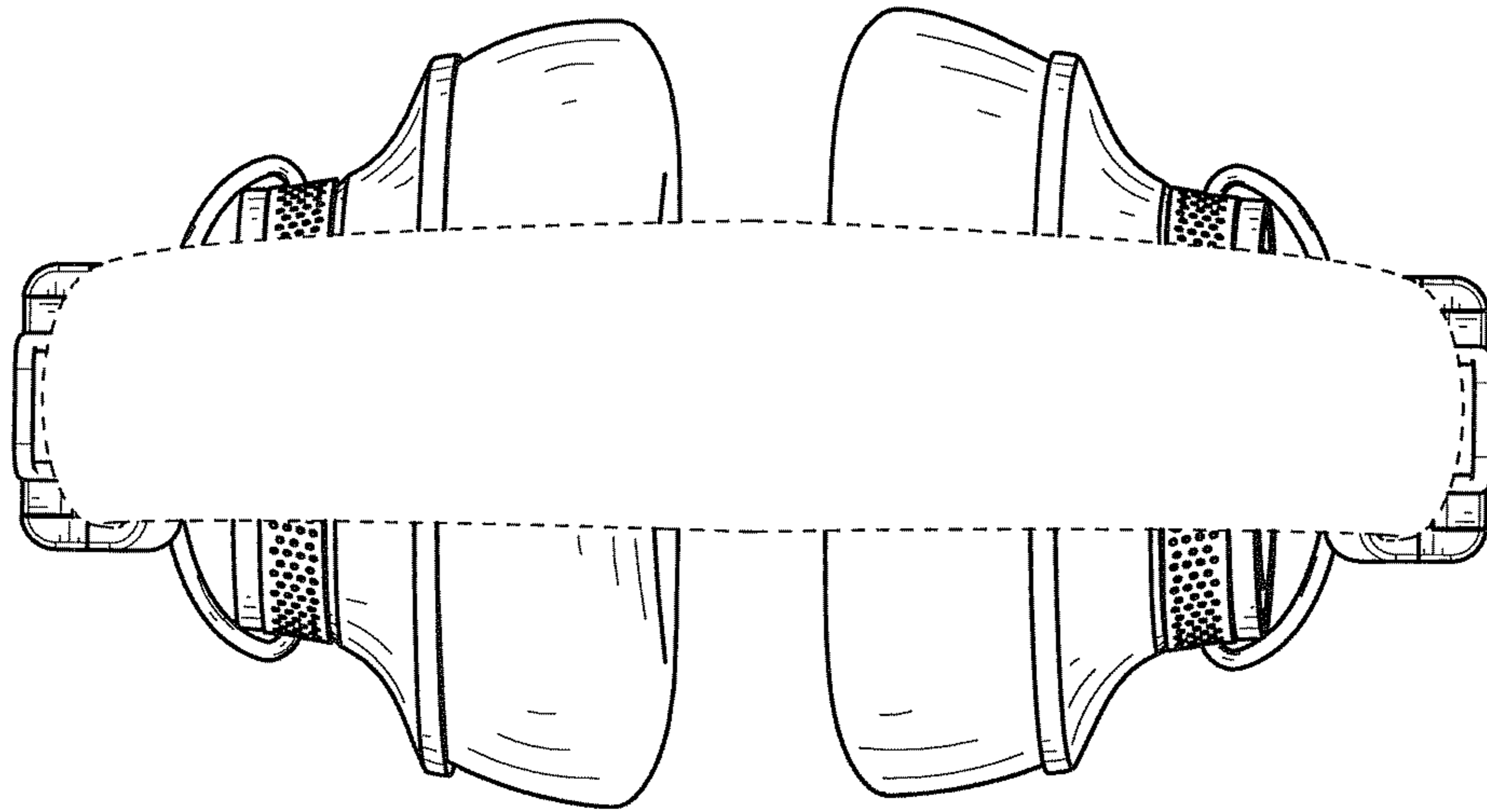


FIG. 6

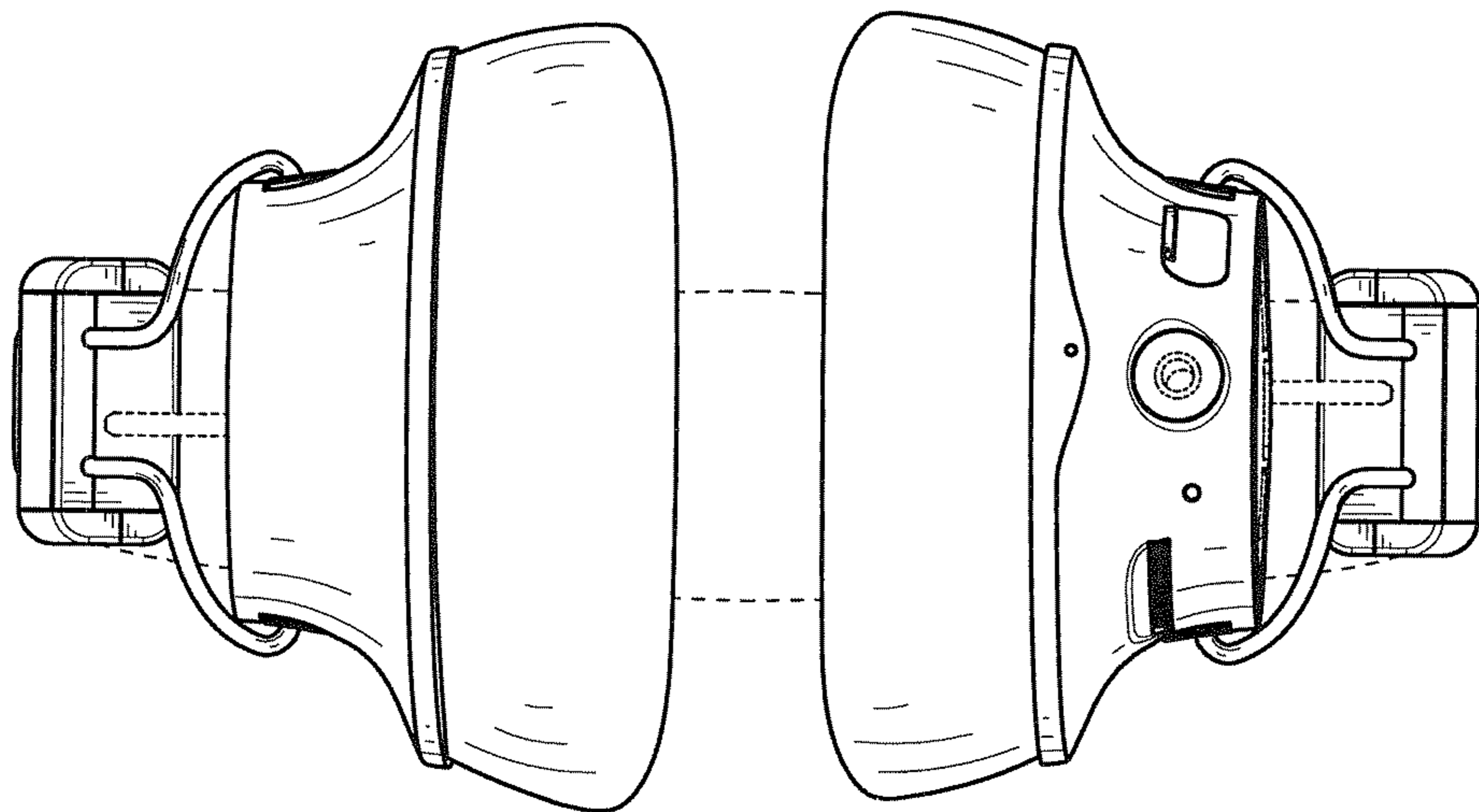


FIG. 7